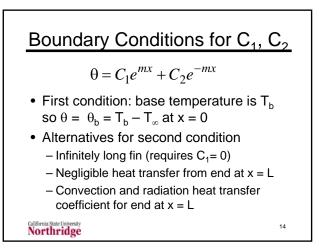
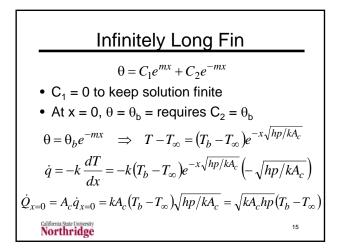
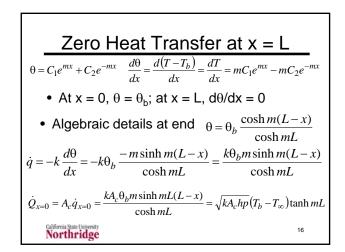
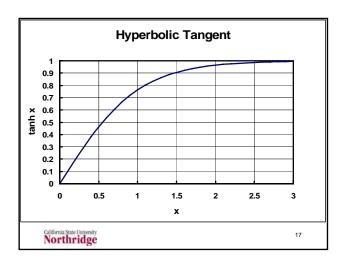


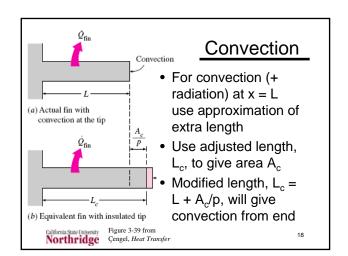
California State University Northridge







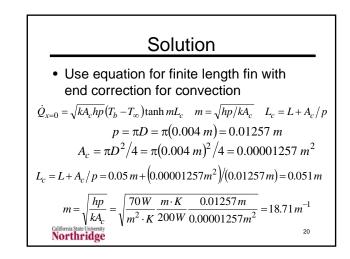


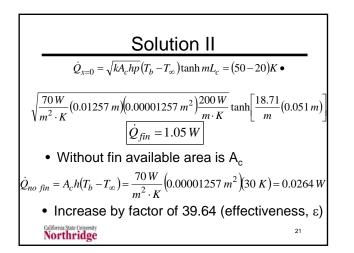


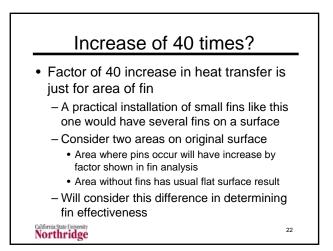
Problem

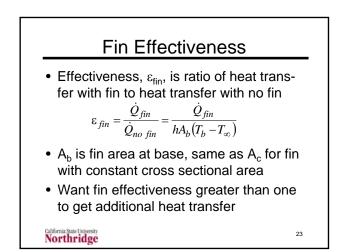
Fins

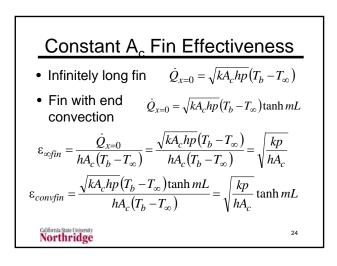
- A pin (cylindrical) fin has a diameter of 4 mm, a length of 5 cm, and a thermal conductivity of 200 W/m·K. If the heat transfer coefficient is 70 W/m²·K, with a surface temperature of 50°C and an air temperature of 20°C, what is the heat transfer with and without the fin?
- Given: $k = 200 \text{ W/m} \cdot \text{K}$, $h = 70 \text{ W/m}^2 \cdot \text{K}$, D = 0.004 m, L = 0.05 m, $T_s = 50^{\circ}\text{C}$, T_{∞} $= 20^{\circ}\text{C}$, Find: Q with and without fin Colored State Universe

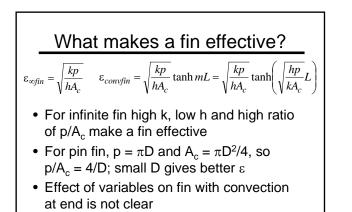




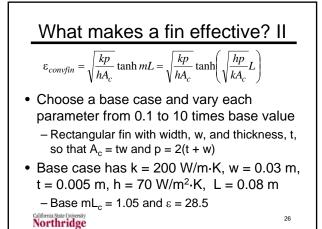




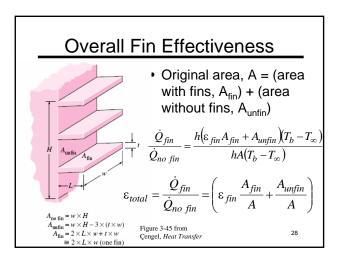


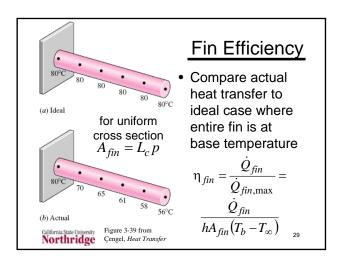


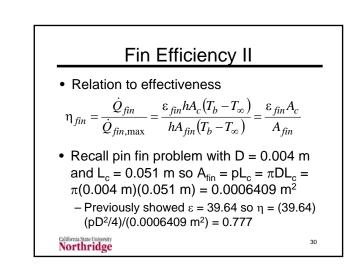
25



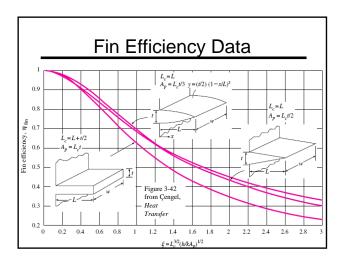
Effect of Parameters on Rectangular Fin Effectiveness 110 Base Case 100 = 200 W/m·K 90 t=0.005 m w = 0.03 m thermal conductivity 80 h = 70 W/m²·K fin thickness, t Fin Effectivenes 70 L = 0.08 m fin width. w 60 mL = 1.05 heat transfer fin length 50 4 30 2 10 n 0.1 10 1 Ratio of parameter to base 27 Northridge

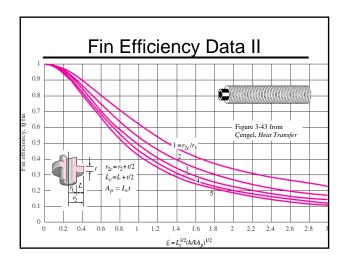






Northridge





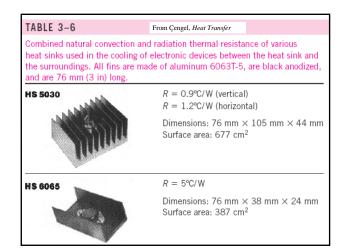
Electronic Heat Sinks

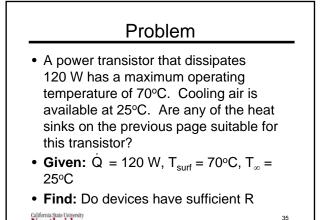
- Designed to protect equipment like power transistors from overheating
- Characterized by thermal resistance, R, such that \dot{Q} = power dissipation = $(T_{device} T_{\infty})/R$
- See Table 3-6 in Çengel for examples with R values
 - First part of table shown on next chart

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California State University Northridge

Fins





California State University Northridge $\dot{Q} = \frac{T_{surf} - T_{\infty}}{R} \implies R = \frac{T_{surf} - T_{\infty}}{\dot{Q}} = \frac{70^{\circ}C - 25^{\circ}C}{40W} = \frac{1.125^{\circ}C}{W}$ • Only the HS 5030 mounted vertically (with R = 0.9°C/W) will satisfy this cooling requirement • The R values for the other heat sinks are too large (1.2°C/W and 5°C/W)

